



30V SYNCHRONOUS N-CHANNEL ENHANCEMENT MODE MOSFET

PowerDI3333-8 (Type D)

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max
Q1	30V	$12m\Omega @ V_{GS} = 5V, I_D = 15A$
Q2	30V	$6m\Omega @ V_{GS} = 5V, I_D = 15A$

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

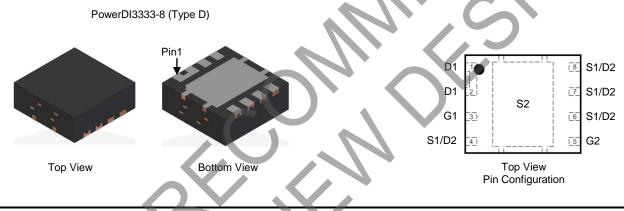
- DC-DC Converters
- Power Management Functions

Features and Benefits

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: PowerDI[®]3333-8 (Type D)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 3
- Weight: 0.044 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMN3012LFG-7	PowerDI3333-8 (Type D)	1000 / Tape & Reel
DMN3012LFG-13	PowerDI3333-8 (Type D)	3000 / Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



N04 = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 = 2018) WW = Week Code (01 to 53)

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Document number: DS38967 Rev. 6 - 3



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Q1	Q2	Unit
Drain-Source Voltage		V _{DSS}	3	0	V
Gate-Source Voltage		V _{GSS}	±'	10	V
	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	I _D	20 16		А
Continuous Drain Current @ $V_{GS} = 5V$	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	1 {	0 3	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	70	100	А
Continuous Source-Drain Diode Current (Note 5)		Is	2.7	3.2	A
Avalanche Current (Note 6) L = 0.1mH		I _{AS}	34	50	A
Avalanche Energy (Note 6) L = 0.1mH		Eas	58	125	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation	$T_{C} = +25^{\circ}C$ $T_{C} = +70^{\circ}C$	PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	58	°C/W
Thermal Resistance, Junction to Case (Note 5)	1(105	R _{θJC}	9.5	0/10
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics Q1 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	_	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current	I _{DSS}		—	1	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	Igss	-	_	±100	nA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						·
Gate Threshold Voltage	V _{GS(TH)}	1	-	2.1	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Static Drain-Source On-Resistance	RDS(ON)	—	10.5	12	mΩ	$V_{GS} = 5V, I_D = 15A$
Forward Transfer Admittance	Y _{fs}	_	27		S	$V_{DS} = 5V, I_D = 15A$
Diode Forward Voltage	Vsd	_	_	1.0	V	$V_{GS} = 0V, I_{S} = 15A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	650	850		
Output Capacitance	Coss	—	314	410	pF	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	—	12	16		
Gate Resistance	Rg	_	1.63	3.3	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	4.7	6.1		
Total Gate Charge at VTH	Q _{g(TH)}	—	0.91	_	nC	V _{DS} = 15V, I _D = 15A
Gate-Source Charge	Q _{gs}	_	1.6		nc	$v_{DS} = 15v, I_D = 15A$
Gate-Drain Charge	Q _{gd}	—	0.9	_		
Turn-On Delay Time	t _{D(ON)}	_	5.1	7.7		
Turn-On Rise Time	t _R	—	2.7	_		$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	—	6.4	9.6	ns	$I_D = 15A, R_G = 2\Omega$
Turn-Off Fall Time	t _F	—	2.3	_		
Reverse Recovery Time	t _{RR}	_	24.5	_	ns	
Reverse Recovery Charge	Q _{RR}	—	8.3		nC	I _F = 15A, di/dt = 300A/μs

5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. Notes:

6. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$. 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.

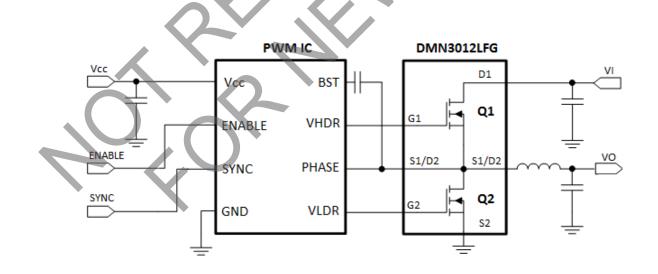


Electrical Characteristics Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						·
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	$V_{GS} = 0V, I_D = 250 \mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}		—	1.0	μA	$V_{DS} = 20V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}		—	±100	nA	$V_{GS} = \pm 10V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.75	—	1.15	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	5.2	6	mΩ	$V_{GS} = 5V, I_{D} = 15A$
Forward Transfer Admittance	Y _{fs}	-	46	—	S	$V_{DS} = 5V, I_{D} = 15A$
Diode Forward Voltage	V _{SD}		—	1.0	V	V _{GS} = 0V, I _S = 15A
DYNAMIC CHARACTERISTICS (Note 8)			_	-		
Input Capacitance	C _{iss}	_	1137	1480	pF	
Output Capacitance	C _{oss}		620	810	pF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss		24	32	pF	
Gate Resistance	R _g	I	0.54	1.1	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg		9.7	12.6	nC	
Total Gate Charge at V _{TH}	Q _{g(TH)}		0.96		nC	V _{DS} = 15V, I _D = 15A
Gate-Source Charge	Q _{gs}	I	1.7		nC	$v_{DS} = 15v, I_D = 15A$
Gate-Drain Charge	Q _{gd}		1.2	—	nC	
Turn-On Delay Time	t _{D(ON)}		4.4	6.6	ns	
Turn-On Rise Time	t _R		3.5		ns	$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(OFF)}		12.4	18.6	ns	$I_D = 15A, R_G = 2\Omega$
Turn-Off Fall Time	tF		2.9	. –	ns	
Reverse Recovery Time	t _{RR}	-	30.5	—	ns	$I_{-} = 150$ di/dt = 2000/(up
Reverse Recovery Charge	Q _{RR}		10.8		nC	I _F = 15A, di/dt = 300A/µs

Notes:7. Short duration pulse test used to minimize self-heating effect.8. Guaranteed by design. Not subject to product testing.

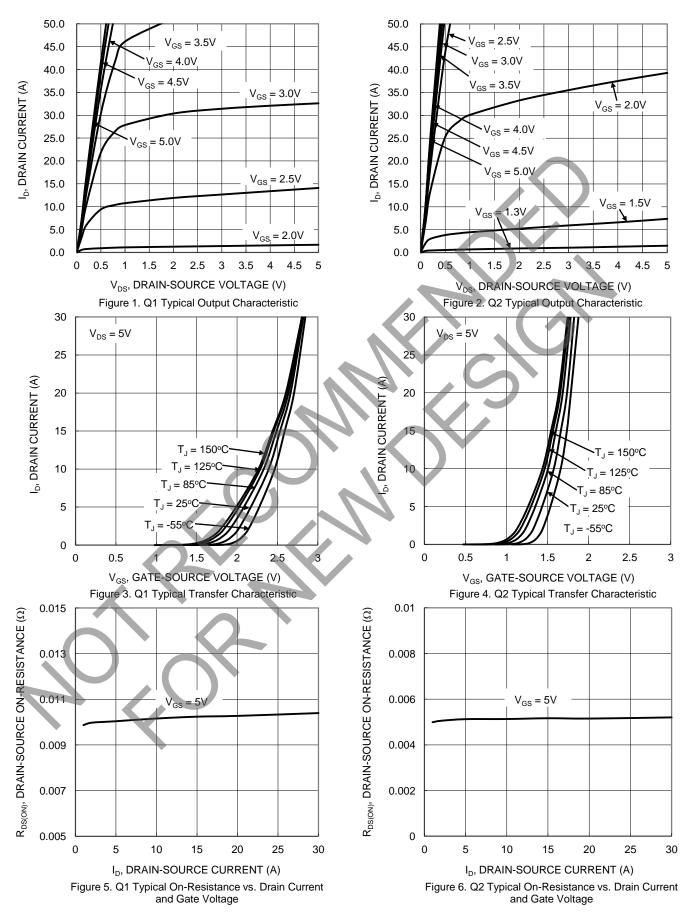
Typical Circuit





NOT RECOMMENDED FOR NEW DESIGN USE <u>DMN3012LDG</u>

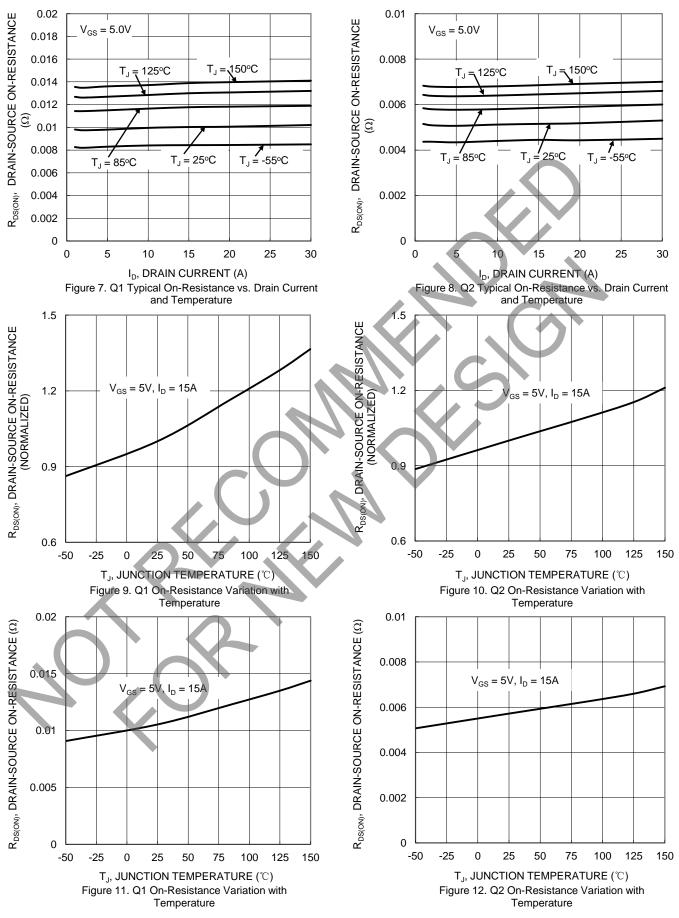
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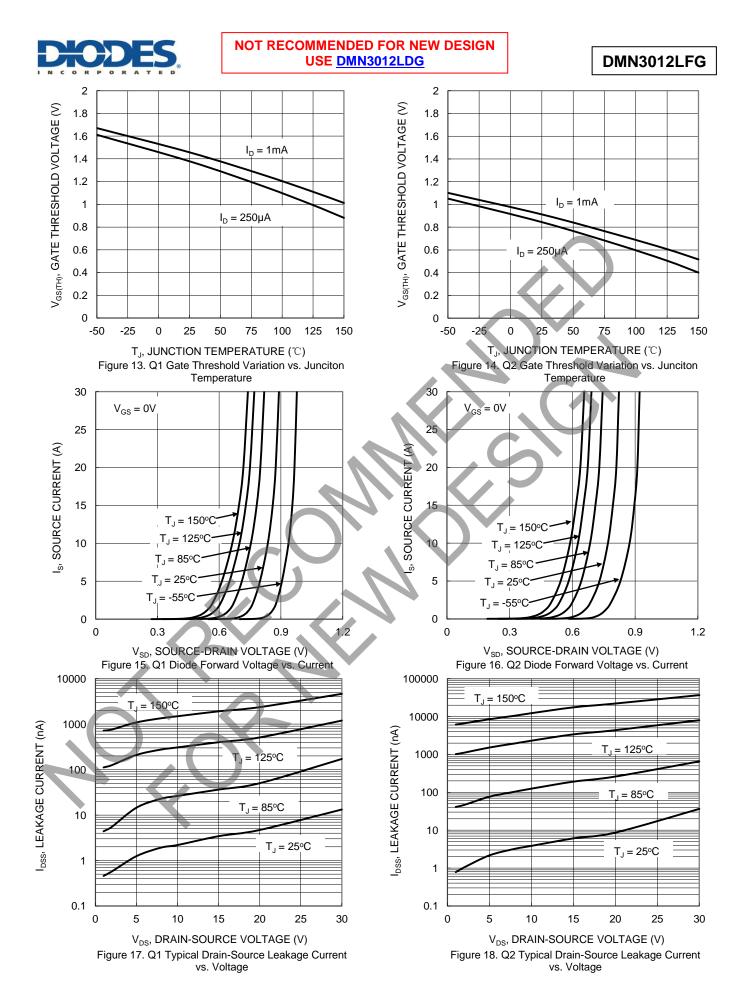


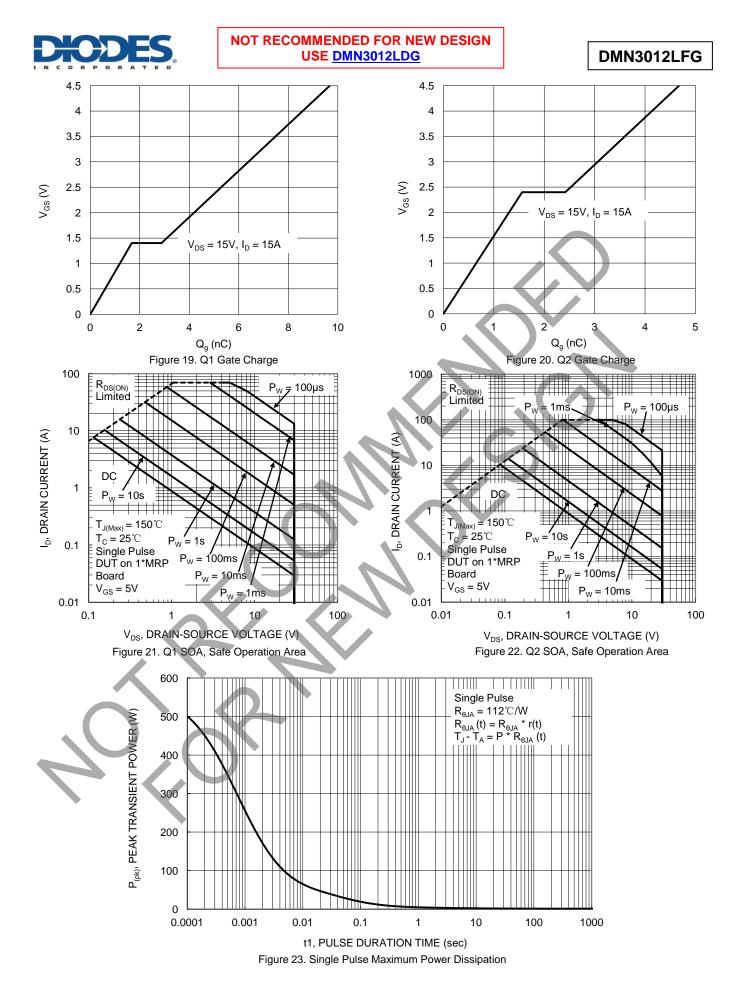


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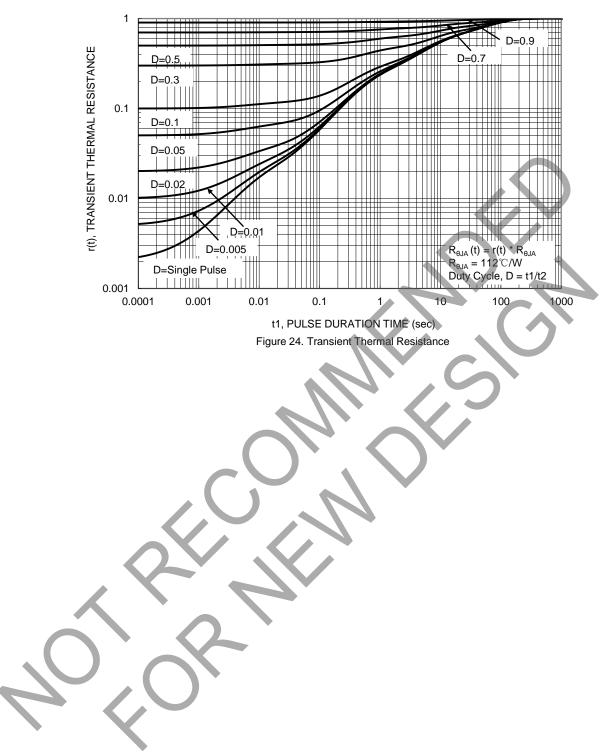






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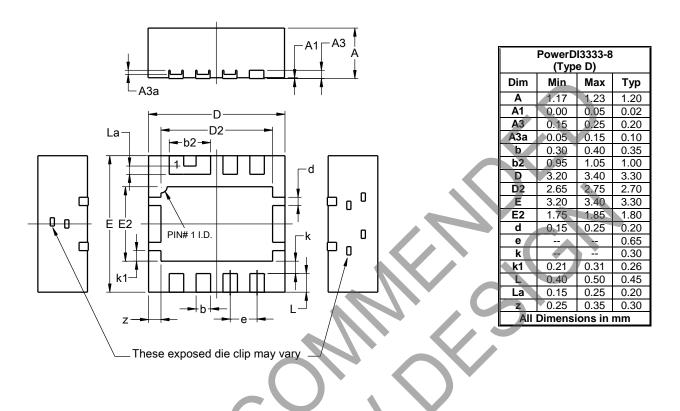




Package Outline Dimensions

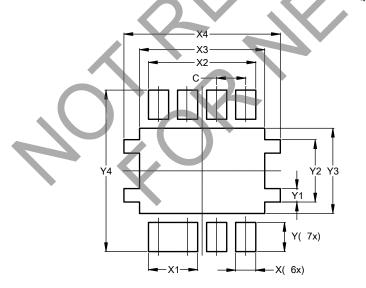
Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type D)



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value				
Dimensions	(in mm)				
С	0.650				
Х	0.450				
X1	1.100				
X2	2.400				
X3	2.800				
X4	3.500				
Y	0.650				
Y1	0.300				
Y2	1.390				
Y3	1.900				
Y4	3.600				

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